PD-96008B

## International **TOR** Rectifier

## IRC740PbF

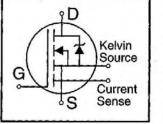
### HEXFET<sup>®</sup> Power MOSFET

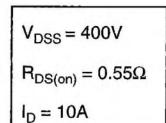
- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Current Sense
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

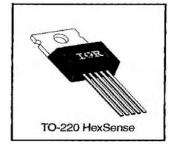
#### Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The HEXSense device provides an accurate fraction of the drain current through the additional two leads to be used for control or protection of the device. These devices exhibit similar electrical and thermal characteristics as their IRF-series equivalent part numbers. The provision of a kelvin source connection effectively eliminates problems of common source inductance when the HEXSense is used as a fast, high-current switch in non current-sensing applications.







#### Parameter Units Max. Ip @ Tc = 25°C Continuous Drain Current, VGs @ 10 V 10 Ip @ Tc = 100°C Continuous Drain Current, VGS @ 10 V A 6.3 Pulsed Drain Current ① IDM 40 $P_D @ T_C \approx 25^{\circ}C$ **Power Dissipation** 125 W Linear Derating Factor 1.0 W/ºC VGS Gate-to-Source Voltage ±20 V Single Pulse Avalanche Energy ② EAS 210 mJ Avalanche Current ① IAR 10 A EAR Repetitive Avalanche Energy ① 13 mJ dv/dt Peak Diode Recovery dv/dt ③ 4.0 V/ns TJ Operating Junction and -55 to +150 Storage Temperature Range TSTG °C Soldering Temperature, for 10 seconds 300 (1.6mm from case) Mounting Torque, 6-32 or M3 screw 10 lbf+in (1.1 N+m)

#### **Thermal Resistance**

	Parameter	Min.	Тур.	Max.	Units
Rejc	Junction-to-Case	-	_	1.0	
R <sub>0CS</sub>	Case-to-Sink, Flat, Greased Surface	-	0.50		°C/W
R <sub>8JA</sub>	Junction-to-Ambient			62	

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#### Absolute Maximum Ratings

	Parameter	Min.	Typ.	Max.	Units	Test Conditions	
V(BR)DSS	Drain-to-Source Breakdown Voltage	400	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> = 250µA	
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient	-	0.49	-	V/°C	Reference to 25°C, Ip= 1mA	
RDS(on)	Static Drain-to-Source On-Resistance	-	-	0.55	Ω	VGS=10V, ID=6.0A @	
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.0	-	4.0	٧	VDS=VGS, ID= 250µA	
<b>g</b> is	Forward Transconductance	5.9	-	-	S	VDS=50V, ID=6.0A @	
IDSS	Drain-to-Source Leakage Current	-	-	25		V <sub>DS</sub> =400V, V <sub>GS</sub> =0V	
	Drain-to-Source Leakage Current		-	250	μA	VDS=320V, VGS=0V, TJ=125°C	
IGSS	Gate-to-Source Forward Leakage	-	-	100	nA	V <sub>GS</sub> =20V	
	Gate-to-Source Reverse Leakage	-	-	-100	nA	V <sub>GS</sub> =-20V	
Qg	Total Gate Charge	-	-	66		I <sub>D</sub> =10A V <sub>DS</sub> =320V	
Q <sub>gs</sub>	Gate-to-Source Charge	-	-	10	nC		
Q <sub>gd</sub>	Gate-to-Drain ("Miller") Charge		-	33		V <sub>GS</sub> =10V See Fig. 6 and 13 @	
t <sub>d(on)</sub>	Turn-On Delay Time	-	14		(	V <sub>DD</sub> =200V	
tr	Rise Time	-	25		ns	$I_D=10A$ $R_G=9.1\Omega$ $R_D=20\Omega$ See Figure 10 ④	
td(off)	Turn-Off Delay Time		54	-	115		
tr	Fall Time	-	24	-	· · · · · ·		
LD	Internal Drain Inductance	-	4.5	-	nH	Between lead, 6 mm (0.25in.) from package and center of die contact	
Ls	Internal Source Inductance	-	7.5	-	ΠĦ		
Ciss	Input Capacitance	-	1200	-		V <sub>GS</sub> =0V V <sub>DS</sub> =25V <i>f</i> =1.0MHz See Figure 5	
Coss	Output Capacitance	-	230	-	pF		
Crss	Reverse Transfer Capacitance	-	48	-			
r	Current Sensing Ratio	2660	-	2940	-	Ip=10A, VGS=10V	
Coss	Output Capacitance of Sensing Cells	-	9.0	-	pF	Vgs=0V, Vps= 25V, f=1.0MHz	

#### Electrical Characteristics @ TJ = 25°C (unless otherwise specified)

#### Source-Drain Ratings and Characteristics

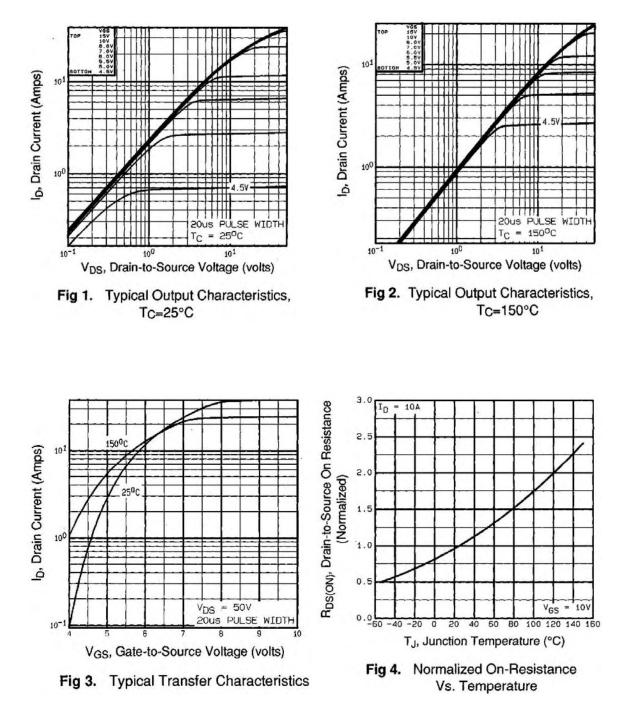
	Parameter	Min.	Тур.	Max.	Units	Test Conditions
ls	Continuous Source Current (Body Diode)	-	-	10		MOSFET symbol showing the
ISM	Pulsed Source Current (Body Diode) ①	-	-	40	A	integral reverse G G G G G G G G G G G G G G G G G G G
VSD	Diode Forward Voltage	-	-	2.0	V	TJ=25°C, Is=10A, VGS=0V @
trr	Reverse Recovery Time	-	330	730	ns	TJ=25°C, IF=10A
Qrr	Reverse Recovery Charge	-	3.2	6.6	μC	di/dt=100A/µs @
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+Lp)				

Notes:

- Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- ③ Isp≤10A, di/dt≤120A/µs, V<sub>DD</sub>≤V(BR)DSS, TJ≤150°C
- ② V<sub>DD</sub>=50V, starting T<sub>J</sub>=25°C, L=3.7mH R<sub>G</sub>=25Ω, I<sub>AS</sub>=10A (See Figure 12)
- ④ Pulse width  $\leq$  300 µs; duty cycle  $\leq$ 2%.

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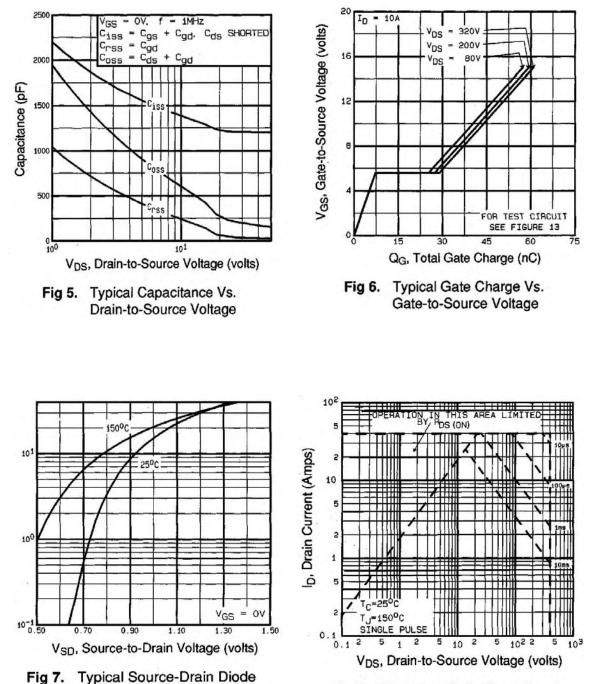
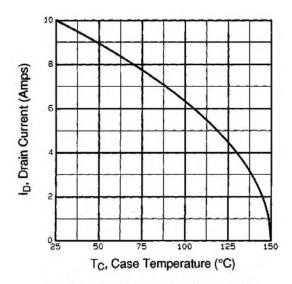


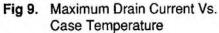
Fig 8. Maximum Safe Operating Area

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Forward Voltage

## International





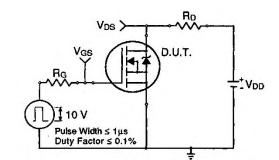


Fig 10a. Switching Time Test Circuit

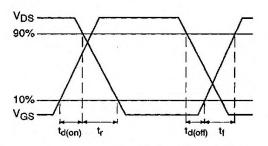


Fig 10b. Switching Time Waveforms

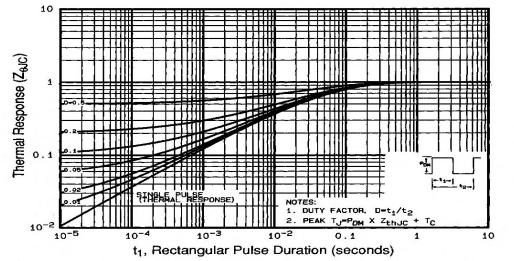


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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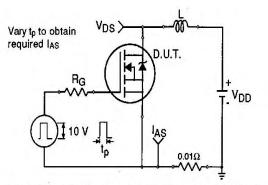


Fig 12a. Unclamped Inductive Test Circuit

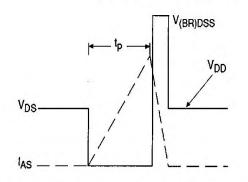


Fig 12b. Unclamped Inductive Waveforms

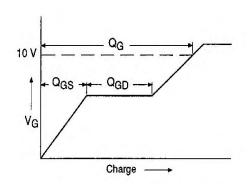


Fig 13a. Basic Gate Charge Waveform

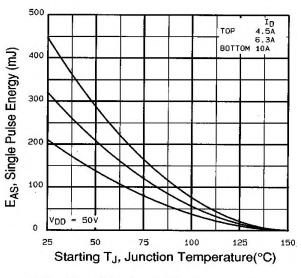


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

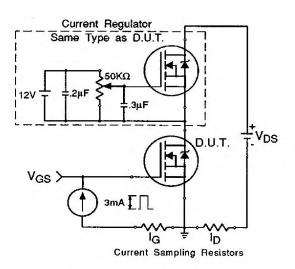


Fig 13b. Gate Charge Test Circuit

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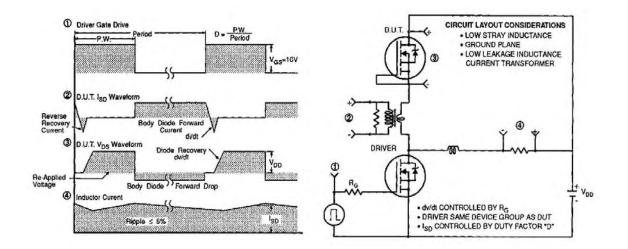
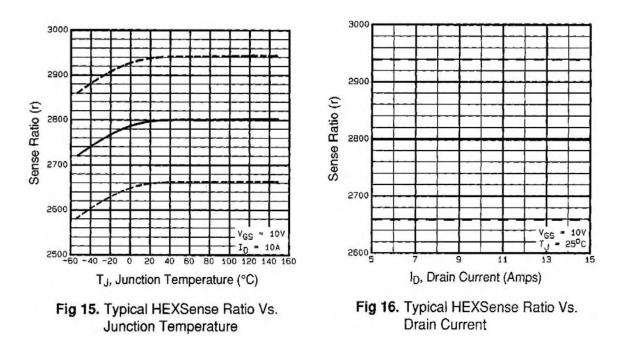
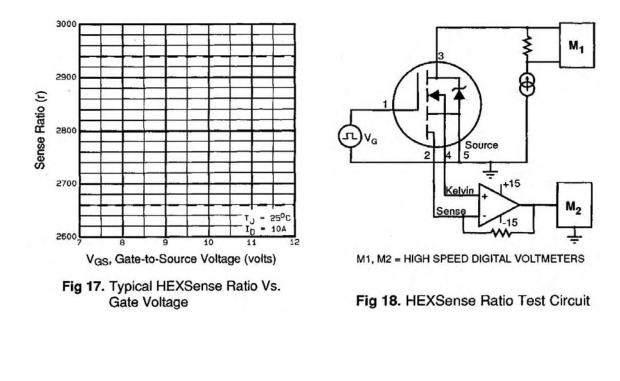


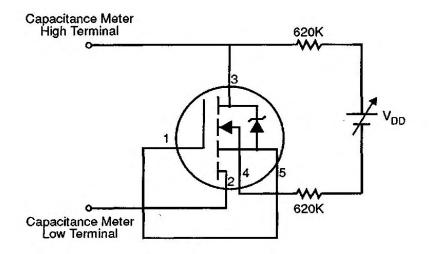
Fig 14. Peak Diode Recovery dv/dt Test Circuit



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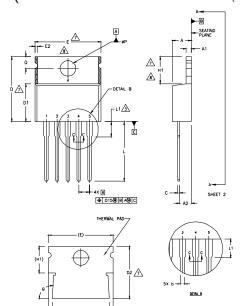




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#### International **TOR** Rectifier HexsenseTO-220 5L Package Outline

( Dimensions are shown in millimeters (inches)



A

DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994. DIMENSIONS ARE SHOWN IN INCHES [MILLIMETERS]. LEAD DIMENSION AND FINISH UNCONTROLLED IN L1.

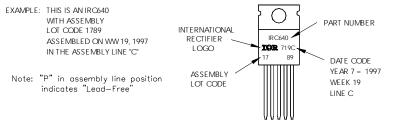
- 3 4 binersion and this of one of the plash, which has a second state of the plash of t
- DIMENSION 61 & c1 APPLY TO BASE METAL ONLY, CONTROLLING DIMENSION : INCHES,

NOTES:

THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E,H1,D2 & E1 DIMENSION E2 X H1 DEFINE A ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED. 8

SYMBOL	MILLIM	ETERS	INCHES		1	
	Min.	MAX.	MIN.	MAX.	NOTES	
A	3,56	4,82	,140	.190		
A1	0.51	1.40	.020	.055		
A2	2.04	2.92	.080	.115		
b	0.64	0.88	.025	.035		
b1	0.64	0.84	.025	.033	5	
с	0.36	0.61	.014	.024		
c1	0.36	0.56	.014	.022	5	
		10.51				
D	14.22	16,51	.560	.650	4	
D1	8.38	9.02	.330	.355		
D2	12.19	12.88	.480	.507	7	
E	9.66	10.66	.380	.420	4,7	
E1	8.38	8.89	.330	.350 BSC	7	
е	1.70	BSC	.067			
H1	5.85	6,55	.230	.270	7,8	
L	13.47	14.09	.530	.555		
L1	-	6.35	-	.250	3	
øР	3.54	4.08	.139	.161		
Q	2.54	3.42	.100	.135		
ø	90*-	-93*	90'-			

### Hexsense TO-220 5L Part Marking Information



Data and specifications subject to change without notice.

## International **ICR** Rectifier

IRC740PbF

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